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Application of

Applicants : Davlin et al.  
Serial No. : 09/651,498  
Filed : August 30, 2000  
Title : Temperature Control Elements, Spindle Assembly, and Wafer  
Processing Assembly Incorporating the Same  
Docket No. : MIO 0071 PA  
Examiner : Ram N. Kackar  
Art Unit : 1763  
Confirm. No.: 1401

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## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE


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James E. Beyer  
39,564  
Reg. No.

Sir:

AMENDMENT ACCOMPANYING  
REQUEST FOR CONTINUED EXAMINATION (RCE)

This paper is being filed in response to the Advisory Action of February 13, 2003 and the Final Rejection of January 6, 2003. Reconsideration of the present application is respectfully requested in light of the amendments and remarks below.

In accordance with the **REVISED AMENDMENT FORMAT** and waiver of 37 CFR 1.121, as promulgated by order of Stephen Kunin, Deputy Commissioner for Patent Examination Policy, on January 31, 2003, the entire set of presently pending claims has been reproduced below in the approved revised amendment format. Any amendments to the specification and drawings have also been presented in the revised format. No separate marked-up copy of the amended claims has been provided.

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